Picture Processor

Preliminary Data

Features

- Noise and cross color reduction by field or frame recursive filtering
- 3 adjustments: 4-dB-, 7-dB- or 12-dB reduction
- Automatic adaption to signal quality during vertical blanking
- Pixel adaptive movement detection
- Split screen modes for demonstration purposes
- Multi-picture facilities
- Picture decimation using vertical filtering
- 8 programmable grey levels for framing
- 4:1:1 and 4:2:2 (Y:U:V) compatibility
- 8-bit word size for all components



Туре	Ordering Code	Package
SDA 9290-5	Q67100-H5088	P-LCC-68-1 (SMD)

Functional Description

The NMOS device SDA 9290-5 is a picture processor and belongs to a family of devices forming an extended third-generation digital TV signal-processing system for enhanced picture quality with special functions (Featurebox). Besides the Picture Processor (PP) that is described here, the system consists of a field memory (at least three triple-port, 1-Mbit generation **TV S**equential-Access Memory devices (SDA 9251 X), a Memory Sync Controller (MSC SDA 9220-5) and a Video **D/A** converter (SDA 9094-5). A block diagram of the Featurebox is shown in **figure 1**.

The Picture Processor SDA 9290-5 is a follow-on development of the Picture Processor SDA 9090 from the second-generation Featurebox and permits further picture improvement by reducing the video noise and cross-color interference. The SDA 9290-5 can be set independently at the picture-signal input and output via the two pins FSBQ/FSI to the 4:1:1 and 4:2:2 formats. A 4:1:1 Featurebox (3 TV-SAMs) can therefore be operated with 4:2:2 input signals as well.

NMOS IC

The necessary decimation and interpolation operations are activated automatically when the format is set. Together with a corresponding Memory Sync Controller (SDA 9220) it enables functions like multi-picture, tuner scanning, picture-in-still and still-in-picture. The different modes can be activated by a microcontroller on the I²C Bus interface (slave receiver). The I²C Bus address for accessing the device is

0	0	1	0	1	0	1	0
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Circuit Description

The core of the picture processor (**see block diagram**) is formed of the Image-Improving Processor (IIP) and the Multi-Picture Processor (MPP). The IIP is responsible for noise and cross-color reduction, while the MPP together with the new Memory Sync Controller implements the functions multi-picture, tuner scanning, picture-in-still and still-in-picture.

Image-Improving Processor

The signal inputs YI0-YI7 and UVI0-UVI7 and the back-channel signal inputs YB0-YB7 and UVB0-UVB7 picture data with 12 bits in quasi-parallel format (4:1:1) and with 16 bits in parallel format (4:2:2). The clock rate for both signals is 13.5 MHz. For signal processing in the IIP and MPP the chrominance bit levels have to be separated in the case of the quasi parallel format by demultiplexers DEMUXS and DEMUXR, these being largely identical in design.

A reduction in video noise is achieved by correlating the picture contents of two successive fields, the non-correlated components (noise) being attenuated by the digital filter. To achieve this, the instantaneous digital picture signal on the outputs of the demultiplexer DEMUXS and the picture signal delayed by a field interval on the outputs of the back-channel demultiplexer DEMUXR are fed to the IIP and combined.

The signal-to-noise ratio (*S/N*) unit detects the noise components of the input signals and the movement detector uses this information to select an appropriate set of parameters with filter coefficients and thresholds for the comparators. For this purpose the luminance signal is assigned to one of three classes according to its *S/N* ratio, with each class defining a different degree of maximum noise reduction. The limits between the middle class and the upper and lower classes can be programmed by the I²C Bus registers R1 and R2 with the values for the thresholds SU and SL. When the picture signals come from a video cassette recorder, the adaptation on the *S/N* ratio of the input signal should be disabled by I²L Bus register R0, VCR bit D2.

Measurement of the signal-to-noise ratio in the automatic mode has been advanced from line 7 to line 6 in order to avoid conflicts with future text and data services.

The degree of noise reduction for the luminance and chrominance signals can be varied between 0 dB and 12 dB by selecting the appropriate filter coefficients.

A picture signal with reduced noise and cross-color appears on the output of the IIP for further processing. The signal will be forwarded via blocks MUXI and MUXO to the picture memories through the outputs (YQ0-YQ7 and UVQO-UVQ7 respectively).

The coefficients of the selected class are controlled by the movement detector as a function of pixels to prevent artifacts (loss of focus) in moving parts of the picture.

Multi-Picture Processor

Signals are processed in the 4:1:1 format. The vertical-decimation line memory now operates with 208 (formerly 216) pixels per line to adapt the 1/9th picture format to the new picture memory with TV-SAMs. Gray frame generation is similarly affected by this change in pixel value.

The signal processing in the decimation filter of the MPP reduces the picture to approximately 1/9th of its original size. This produces a basis for new features, the full implementation of which calls for a matching MSC (SDA 9220).

Figure 5 shows how the screen is divided up. The following modes can be implemented with the MPP:

1. Multi-Picture (automatic)

Fields are extracted from a sequence of movements at fixed intervals, reduced and reproduced on the screen as a sequence of stills. At one position it is possible to show a moving picture.

- 2. Multi-Picture (manual) This differs from the above in that the viewer can determine at the push of a button what phases of movement are to be stored.
- 3. Multi-Picture (tuner scanning)

The pictures of the sequence of stills are derived from the different TV channels and give an overview of the programs on offer. In this mode the picture memory is operated with a crystal-controlled clock to ensure that the picture remains stable when switching from one channel to another.

4. Still-in-Picture

A field is extracted from the on-going program, reduced and inserted as a still in the master channel.

5. Picture-in-Still

The on-going program is inserted as a reduced-size moving picture in a still.

The framing block that follows the decimation filter in the MPP permits frames to be inserted in order to border the reduced-size pictures on the screen. The brightness of the framing can be varied in eight steps by the I²C Bus.

The format conversion produced in the demultiplexers for signal processing in the IIP and MPP is reversed again in the multiplexer MUXO. The picture signal appears again in quasi-parallel format or parallel format on the output of the MUXO block. The inputs of the TV-SAMs are directly driven by the sixteen outputs YQ0-YQ7 and UVQ0-UVQ7.

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I²C Bus Interface

An I²C Bus interface configured as a "slave receiver" is used for programming the different functions and modes of the picture processor. Via this interface up to four registers can be written according to the following transfer protocol for controlling the operation mode:

S	Slave Address	0 A	Sub Address	A	Data Byte	A		AP
))	

S: Start condition

A: Acknowledge

P: Stop condition

Slave address: 0 0 1 0 1 0 1

(Note: There is a general description of the I²C Bus in the Siemens publication "I²C Bus Technical Description".)

After every data byte that is transmitted the internal register address (subaddress) is automatically incremented to the next register so that, if necessary, several registers can be loaded with one I²C Bus telegram.

In the multi-picture mode the operating mode transmitted on the I²C Bus is switched within the vertical blanking interval, i.e. during the high phase of signal VS1, if the Memory Sync Controller (MSC) activates the DREQ line during this period.

It should be noted that the new operating mode has always to be transmitted to the picture processor first and immediately afterwards to the MSC on the I²C Bus at an interval not longer than 30 ms.

This is the only way to ensure interference-free synchronization of the picture processor and the MSC. The four I²C Bus registers are described below in more detail. The values marked "*D" in the right-hand margin are set by an internally generated reset signal (default values) when the operating voltage is applied.

Register	Sub-	Data Byte							
	address ¹⁾	D7	D6	D5	D4	D3	D2	D1	D0
R0	00	B1	B0	FR	0	SS	VCR	NR	SUV8
R1	01	YF5	YF4	YF3	SL4	SL3	SL2	SL1	SL0
R2	02	0	0	0	SU4	SU3	SU2	SU1	SU0
R3	03	SNTEN	SNT1	SNT0	KTEN	КТ3	KT2	KT1	KT0

*D

Mode	B1	B0	
Normal	0	0	
Multi-picture (MP)	0	1	
Still-in-picture (SIP)	1	0	
Picture-in still (PIS)	1	1	
			-
MPP: Narrow Frame	FR		
Without narrow frame	0		
With narrow frame	1		
	Normal Multi-picture (MP) Still-in-picture (SIP) Picture-in still (PIS) MPP: Narrow Frame Without narrow frame	Normal0Multi-picture (MP)0Still-in-picture (SIP)1Picture-in still (PIS)1MPP: Narrow FrameFRWithout narrow frame0	Normal00Multi-picture (MP)01Still-in-picture (SIP)10Picture-in still (PIS)11MPP: Narrow FrameFRWithout narrow frame0

Register R0: This control register sets the operating mode of the picture processor.

Bit D4:	No function; default 0
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Bit D3:	Display Mode	SS	
	Full screen	0	*D
	Split screen	1	

Specialities:

Split Screen Display

For demonstration purposes the noise reduction can be disabled for half of the picture by means of I²C Bus register R0, bit D3. In this way a direct comparison is possible between a noise-reduced (filtered) and an unfiltered picture.

			_
Bit D2:	Control of SNR adaptation	VCR	
	TV mode	0	*D
	VCR mode	1	
			-
Bit D1:	Noise reduction ON/OFF	NR	
	Noise reduction OFF	0	*D
	Noise reduction ON	1	
			-
Bit D0:	Word width input	SUV8	
	7 bits	0	1
	8 bits	1]

Register R1: This control register sets the frame luminance for multi-picture and the threshold SL for S/N adaptation.

Bits D7-D5:

Frame Luminance YF		YF5	YF4	YF3	
0	black	0	0	0	*D
:	:	:	:	:	
:	:	:	:	:	
:	:	:	:	:	
7	white	1	1	1	

Bits D4-D0:

Threshold SL (S/N adaptation)	SL4	SL3	SL2	SL1	SL0
0	0	0	0	0	0
:	:	:	:	:	:
:	:	:	:	:	:
4	0	0	1	0	0
:	:	:	:	:	:
:	:	:	:	:	:
31	1	1	1		1

Register R2: This control register sets the threshold SU for S/N adaptation.

Bits D7-D5: No function; default 0

4-D0:	Threshold SL (S/N adaptation)	SU4	SU3	SU2	SU1	SU0	
	0	0	0	0	0	0	1
	:	:	:	:	:	:	
	:	:	:	:	:	:	
	16	1	0	0	0	0	*D
		:	:	:	:	:	
	:	:	:	:	:	:	
	31	1	1	1	1	1	

Register R3: This register is for testing.	certain S/N classes and filter coefficients for the motion
detector can be firmly set.	

Bits D7-D5:	S/N Class	SNTE	N	SNT1		SNT0]
	Automatic adaptation	0		Х		Х	*D
	Class 0	1		0		0	
	Class 1	1		0		1	
	Class 2	1		1		0	
		1				1	-
Bits D4-D0:	Filter Coefficient	KTEN	KT3	KT2	KT1	KT0	
	Motion detector ON	0	Х	X	Х	X	*D
	K = 1	1	0	0	0	0	
	K = 3/4	1	0	0	0	1	
	K = 5/8	1	0	0	1	0	
	K = 9/16	1	0	0	1	1	
	K = 3/4	1	0	1	0	0	
	K = 1/2	1	0	1	0	1	
	K = 3/8	1	0	1	1	0	
	K = 5/16	1	0	1	1	1	
	K = 5/8	1	1	0	0	0	
	K = 3/8	1	1	0	0	1	
	K = 1/4	1	1	0	1	0	
	K = 3/16	1	1	0	1	1	
	K = 9/16	1	1	1	0	0	
	K = 5/16	1	1	1	0	1	1
	K = 3/16	1	1	1	1	0	1
	K = 1/8	1	1	1	1	1	

Note: X is ignored.

*D = Default values after reset.



Block Diagram

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Pin Configuration

(top view)



Pin Definitions and Functions

Pin No.	Symbol	Function	Description
1	V _{DD}	Positive supply voltage (+ 5 V)	Positive supply voltage (+ 5 V)
2-9	UVQ7 UVQ0	Data outputs	Push-pull outputs for directly driving the TV-SAM chrominance inputs: 8 bits for 4:2:2 format; 4 bits for 4:1:1 format; [UVQ0 UVQ3 only valid for 4:2:2 format]
10	V _{SS}	Ground	Ground (0 V)
11-18	UVB0 UVB7	Back-channel data outputs	Back-channel inputs for chrominance data from TV-SAM
19-26	YB0 YB7	Back- channel data inputs	Back-channel inputs for luminance data from TV-SAM
27-34	UVI0 UVI7	Data inputs	Data inputs for chrominance data accept the dig. YUV signal
35-42	YI0 YI7	Data inputs	Data inputs for luminance data accept the dig. YUV signal
43	DREQ	Data request signal for multi- picture mode	Data-request input; initiates data transfer in multi-picture mode and switches mode together with signal VS1
44	V _{SS}	Ground	Ground (0 V)
45	BLN	Blanking signal (15.625 kHz)	Input for line-synchronous blanking signal that determines line blanking interval (active low) and synchronizes clock and sequence control
46	LLIN	First system clock (13.5 or 27 MHz)	Input for line-locked system clock, optionally 13.5 MHz or 27 MHz, from which internal timing is derived. Positive edge indicates validity of input data
47	LLSEL	Selection of system clock frequency (LLIN)	Selection of input clock frequency at pin LLIN for adapting the IC to the system clock. Low level for 27-MHz clock frequency; high level for 13.5-MHz clock frequency; no switching inactive mode without picture interference
48	LL3X	Second system clock (13.5 MHz)	Input for line-locked 13.5-MHz clock that ensured picture stability in multi-picture mode and is used as output clock in every mode
49	SCL	I ² C Bus shift clock input	I ² C Bus shift-clock input

Pin Definitions and Functions (cont'd)

Pin No.	Symbol	Function	Description
50	SDA	I ² C Bus data input/output	I ² C Bus data input/output
51	VS1	Vertical sync input (50 Hz)	Vertical sync input; determines vertical position of TV picture for 50-Hz or 60-Hz field frequency
52	V _{DD}	Positive supply voltage (+ 5 V)	Positive supply voltage (+ 5 V)
53	FSBQ	Selection of output format	Switching of data output format: Low level for 4:1:1 format; high level for 4:2:2 format
54	FSI	Selection of input format	Switching of data input format: Low level for 4:1:1 format; high level for 4:2:2 format
55	CLKEN	Connect test pin 2	Has to be grounded (0 V) in normal mode
56	SPEN	Connect test pin 2	Has to be grounded (0 V) in normal mode
57-59	N.C.	Reserved	No connections possible or meaningful
60	V _{SS}	Ground	Ground (0 V)
61-68	YQ7 YQ0	Data outputs	Push-pull outputs for directly driving TV-SAM inputs for 4:1:1 and 4:2:2 modes; (8-bit luminance)

Absolute Maximum Ratings

(all voltages are referred to $V_{\rm SS}$)

Parameter	Symbol	Limi	t Values	Unit	Remarks	
		min.	max.			
Ambient temperature	T _A	0	70	°C		
Storage temperature	$T_{ m stg}$	- 40	125	°C		
Total power dissipation	P _{tot}		2.5	W		
Supply voltage	V _{DD}	- 0.3	6	V		
Input/output voltage	V _{I/Q}	- 0.3	6	V		
Thermal resistance system-air	R _{th SA}		25	K/W	with heat sin	

Operating Range

Supply voltage	$V_{ m DD}$	4.5	5.5	V	
Supply current	I _{DD}		450	mA	
Ambient temperature	T _A	0	70	°C	

Characteristics

(all voltages are referred to $V_{\rm SS}$)

Parameter	Symbol	L	imit Val	ues	Unit	Test Condition
		min.	typ.	max.		
H-input voltage 1)	V_{IH}	2.0		5.5	V	
L-input voltage 1)	V_{IL}	0		0.8	V	
Input current ¹⁾	I _{IR}			10	μA	
Input capacitance ¹⁾ (except BLN, LLIN)	Cı			10	pF	
Input capacitance ¹⁾ (only BLN, LLIN)	C			5	pF	
H-input voltage ²⁾	V _{IH}	3.0		5.5	V	
L-input voltage 2)	V _{IL}	0		0.8	V	
Input capacitance 2)	C_{I}			10	pF	
Input current ²⁾	I _{IM}			10	μA	
H-output voltage 3)	V_{QH}	2.4			V	$I_{\rm QH} = -2.0 \rm mA$
L-output voltage 3)	V_{QL}			0.4	V	$I_{\rm QH} = 3.0 \rm mA$
L-output voltage 4)	V_{QL}			0.4	V	$I_{\rm QH} = 3.0 \rm mA$
Permissible output voltage 4)	V_{QM}			5.5	V	

¹⁾ Input signals UVI0 … UVI7, YI0 … YI7, UVB0 … UVB7, YB0 … YB7, BLN, LLSEL, FSI, FSBQ, LLIN, LL3X, DREQ, VS1

²⁾ Input signals SDA, SCL (refer to figure 3)

³⁾ Output signals YQ0-YQ7, UVQ0-UVQ7

⁴⁾ Output signal SDA (open drain)

Characteristics (cont'd)

(all voltages are referred to V_{SS})

Parameter	Symbol	Limit Values		Unit	Test Condition	
		min.	typ.	max.		

Input Clock LL3X = 13.5 MHz (refer to figure 3)

Cycle	T _{LLL3X}	68	74	80	ns	
Fall time	t _{THL}			5	ns	
Rise time	t _{THL}			5	ns	
H-pulse width	t _{WH}	25			ns	
L-pulse width	t _{WL}	25			ns	
Change in rel to LLIN	t _{SK}	0		15	ns	

Input Clock LLIN (refer to figure 3)

Cycle	T _{LLIN}	68	74	80	ns	LLSEL = high
H-pulse width	t _{WH}	25			ns	LLSEL = high
L-pulse width	t _{WL}	25			ns	LLSEL = high
Cycle	T _{LLIN}	35	37	40	ns	LLSEL = low
H-pulse width	t _{WH}	10			ns	LLSEL = low
L-pulse width	t _{WL}	10			ns	LLSEL = low
Fall time	t _{THL}			5	ns	
Rise time	t _{THL}	2		5	ns	

Input Clock BLN (refer to figure 2)

Setup time	t _{SU}	7		ns	LLSEL = low
Hold time	t _{IH}	6		ns	LLSEL = low
Setup time	t _{SU}	15		ns	LLSEL = high
Hold time	t _{IH}	5		ns	LLSEL = high
H-pulse width	t _{wH}		720	T _{LL3X}	
Cycle, 625 lines	T _{BLN}		864	T _{LL3X}	
Cycle, 525 lines	T _{BLN}		858	T _{LL3X}	

Characteristics (cont'd)

(all voltages are referred to V_{SS})

Parameter	Symbol	Limit Values		Unit	Test Condition	
		min.	typ.	max.		

Input Signal VS1

Setup time	t _{SU}	15			ns	Reference LL3X
Hold time	t _{IH}	5			ns	Reference LL3X
Cycle, 625 lines	T _{VS1}		312.5		T _{BLN}	
Cycle, 525 lines	T _{VS1}		262.5		T _{BLN}	
H-pulse width, 625 lines	t _{wH}			26.5	T _{BLN}	
L-pulse width, 525 lines	t _{WL}			16.5	T _{BLN}	

Input Signal DREQ

Setup time	t _{SU}	15		ns	Reference LL3X
Hold time	t _{IH}	5		ns	Reference LL3X
H-pulse width	t _{wH}	1	16	T _{LL3X}	

Input Signal (Data) YI0 ... YI7, UVI0 ... UVI7, YB0 ... YB7, UVB0 ... UVB7 (refer to figure 2)

Setup time	t _{su}	15	ns	Reference LL3X
Hold time	t _{IH}	5	ns	Reference LL3X
Setup time	t _{su}	15	ns	Reference LLIN
Hold time	t _{IH}	5	ns	Reference LLIN

Output Signal (Data) YQ0 ... YQ7, UVQ0 ... UVQ7 (refer to figure 2)

Hold time	t _{QH}	6		ns	Reference LL3X
Delay time	t _{QD}		50	ns	Reference LL3X $C_{L} = 30 \text{ pF}$



Figure 1 Application Circuit (simplified)

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Figure 2 Timing Diagram





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Figure 4 Timing for I²C Bus

All values are referred to specified input levels $V_{\rm IH}$ and $V_{\rm IL}$

Parameter	Symbol	Limit Values		Unit
		min.	max.	
Clock frequency	f _{scl}	0	100	kHz
Inactive time before start of new transmission	t _{BUF}	4.7		μs
Hold time for start condition (after this time first clock pulse is generated)	t _{HD; STA}	4.0		μs
Low clock phase	t _{LOW}	4.7		μs
High clock phase	t _{HIGH}	4.0		μs
Setup time for data	t _{SU; DAT}	250		ns
Rise time for SDA and SCL signals	t _{TLH}		1	μs
Fall time for SDA and SCL signals	t _{THL}		300	ns
Setup time for SCL clock in stop condition	t _{SU; STO}	4.7		μs





Y:7-Bit Signal	Y:8-Bit Signal	Picture Processor				
		Input	Back Channel Input	Output		
Y6	Y7	YI7	YB7	YQ7		
Y5	Y6	YI6	YB6	YQ6		
Y4	Y5	YI5	YB5	YQ5		
Y3	Y4	YI4	YB4	YQ4		
Y2	Y3	YI3	YB3	YQ3		
Y1	Y2	YI2	YB2	YQ2		
Y0	Y1	YI1	YB1	YQ1		
-	Y0	YI0	YB0	YQ0		
U6 U4 U2 U0	U7 U5 U3 U1	UVI7	UVB7	UVQ7		
U5 U3 U1	U6 U4 U2 U0	UVI6	UVB6	UVQ6		
V6 V4 V2 V0	V7 V5 V3 V1	UVI5	UVB5	UVQ5		
V5 V3 V1	V6 V4 V2 V0	UVI4	UVB4	UVQ4		

Y: Luminance SignalU: Chrominance SignalV: Chrominance Signal

Figure 6 Assignment of Signal and Pin Names

Format 4:1:1

Signal	Picture Processor					
	Input	Back Channel Input	Output			
Y7	YI7	YB7	YQ7			
Y6	YI6	YB6	YQ6			
Y5	YI5	YB5	YQ5			
Y4	YI4	YB4	YQ4			
Y3	YI3	YB3	YQ3			
Y2	YI2	YB2	YQ2			
Y1	YI1	YB1	YQ1			
Y0	YI0	YB0	YQ0			
UV7	UVI7	UVB7	UVQ7			
UV6	UVI6	UVB6	UVQ6			
UV5	UVI5	UVB5	UVQ5			
UV4	UVI4	UVB4	UVQ4			
UV3	UVI3	UVB3	UVQ3			
UV2	UVI2	UVB2	UVQ2			
UV1	UVI1	UVB1	UVQ1			
UV0	UVI0	UVB0	UVQ0			

Figure 7 Assignment of Signal and Pin Names

Format 4:2:2



